

## Low Voltage and High Speed Dual SPDT Analog Switch with True Isolation

#### **Descriptions**

The RLCS23157 is a dual SPDT low on-resistance analog switch. It can operate from a single 1.5V to 5.5V power supply. The device offers low ON-state resistance and excellent ON-state resistance matching with break-before-make feature, to prevent signal distortion during the transferring of a signal from one channel to another. The device is capable of true isolation. Even when COMx overrides VCC, very little current will flow back to the supply.

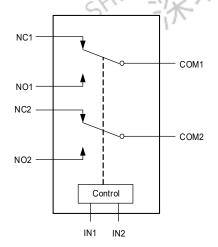
#### **Features**

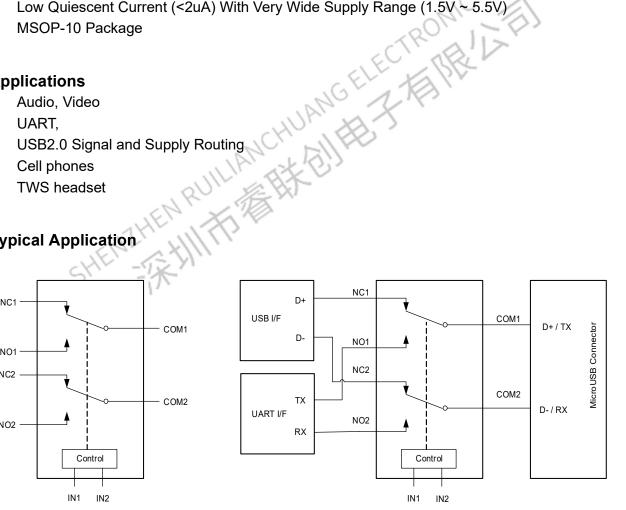
- Low On-resistance, Ron= $1.5\Omega$  when COMX=5V
- 1.8V Logic Compatible Control Pin
- COMx Overrides VCC to Achieve True Isolation Even When Supply Is Dead
- High Off-Isolation: -100dB @ 100KHz
- Low Channel-to-Channel Crosstalk: -97dB @ 100KHz
- High Bandwidth (-3dB @700MHz) Suitable For USB2.0 High-Speed Routing
- Low Quiescent Current (<2uA) With Very Wide Supply Range (1.5V ~ 5.5V)

### **Applications**

- Cell phones

# **Typical Application**

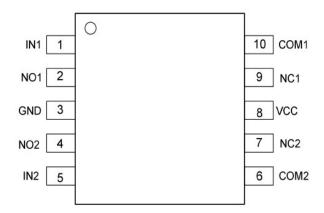




Configured as USB2.0 Mux



## **Functions and Pin Configuration**



MSOP-10L

**Pin Descriptions** 

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Pin Number	Symbol	Descriptions
1,5	IN <sub>X</sub>	Logic Input Control
2,4	NO <sub>X</sub>	Analog/Digital Signal Ports (Normally open)
3	GND	Ground
6,10	COMX	Common Signal Ports
7,9	NCX	Analog/Digital Signal Ports (Normally closed)
8	VCC	Single Power Supply

**Function Descriptions** 

Logic Input(INX)	Function	
0	NC1=COM1 and NC2=COM2	
1 THEIR	NO1=COM1 and NO2=COM2	

Note: X= 1 or 2

# Order Information

Package		Part Number	Quantity Per Reel	
MSOP -10L	Tape and Reel	RLCS23157MS10/R6	3,000PCS	



**Absolute Maximum Ratings** (1)

Parameter	Symbol	Value	Unit
Supply Voltage	Vcc	-0.3 ~ 6.5	V
Control Input Voltage	V <sub>IN</sub>	-0.3 ~ 6.5	V
Continuous Current Through NO, NC, COM		±100	mA
Peak Current Through NO, NC, COM (pulsed at 1ms 50% duty cycle)		±200	mA
Storage Temperature Range	T <sub>STG</sub>	-55 ~ 150	°C
Junction Temperature under Bias	TJ	150	°C
Lead Temperature (Soldering, 10 seconds)	TL	260	°C
Power Dissipation	$P_D$	250	mW

Recommend operating ratings (2)

Parameter	Symbol	Value	Unit
Supply Voltage Operating	V <sub>CC</sub>	1.5 ~ 5.5	V
Control Input Voltage	V <sub>IN</sub>	-0.3 ~ 5.5	V
Input Signal Voltage	V <sub>COM</sub>	-0.3 ~ 5.5	V
Operating Temperature	TA	-40 ~ 85	°C
Thermal Resistance	$R_{ heta JA}$	360	°C/W

#### Note:

1. "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.



## **DC Electronics Characteristics** (Ta=25°C, VCC=3.3V, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Innut Innia himb Inval	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	VCC: 3.3 ~ 5.5V	1.6			V
Input logic high level	V <sub>IH</sub>	VCC: 1.5 ~ 3.3V	1.4			V
Input logic low lovel	V.	VCC: 3.3 ~ 5.5V			0.6	V
Input logic low level	VIL	VCC: 1.5 ~ 3.3V			0.4	V
Supply quiescent current	Icc	I <sub>COM</sub> =0, V <sub>IN</sub> =0 or V <sub>IN</sub>			1.0	uA
Supply quiescent current	ICC	=VCC			1.0	uA
Increase in I <sub>CC</sub> per input	I <sub>CCT</sub>	I <sub>COM</sub> =0, VCC=4.5V			1.0	uA
morease in ico per input	ICCI	V <sub>IN</sub> >1.8 or V <sub>IN</sub> <0.5			1.0	uA
Off state leakage from	Icomx	$V_{COM} = 5.5V$ , $V_{NC(or NO)} =$		±20	±40	nA
COM <sub>x</sub> to NC <sub>x</sub> (or NO <sub>x</sub> )	TCOMX	0V		120	140	
	R <sub>ON1</sub>	$V_{COM} = 0 \sim 0.5 V$ ,		3.0	3.5	Ω
	TON1	I <sub>COM</sub> =30mA		0.0	0.0	32
	R <sub>ON2</sub>	$V_{COM} = 0.5 \sim 2.0 V$ ,	36	3.6	3.9	Ω
On-Resistance		I <sub>COM</sub> =30mA	110		0.0	32
	Ron3	$V_{COM}=2.0 \sim 4.0 V$ ,	1.	2.5	3.5	Ω
		I <sub>COM</sub> =30mA	0,1	7	0.0	
	R <sub>ON4</sub>	$V_{COM}$ =4.0 ~ 5.5V,	5/2	1.5	1.8	Ω
	1.50	I <sub>COM</sub> =30mA	`			
	RFLAT1	$V_{COM} = 0 \sim 0.5 V$ ,		0.7		Ω
		I <sub>COM</sub> =30mA		_		
	R <sub>FLAT2</sub>	$V_{COM}=0.5 \sim 2.0V$ ,		0.5		Ω
On-Resistance Flatness		I <sub>COM</sub> =30mA	0.0			
	RFLAT3	$V_{COM}=2.0 \sim 4.0 V$ ,		1.6		Ω
	. XO W	I <sub>COM</sub> =30mA				
CML 17	R <sub>FLAT4</sub>	$V_{COM}=4.0 \sim 5.5V$ ,		0.3		Ω
CHY - 12	λ/	I <sub>COM</sub> =30mA				
On-Resistance	ΔRon	V <sub>COM</sub> =0~5.5V, I <sub>COM</sub> =30mA,		0.1	0.2	Ω
Matching Between Channels		,				

## AC Electronics Characteristics (Ta=25℃, VCC=3.3V, unless otherwise noted)

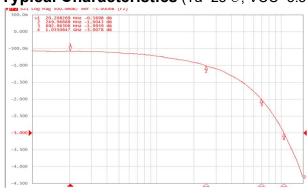
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Turn-On Time	T <sub>ON</sub>	$V_{COM}$ =1.5V, $C_L$ =35pF, $R_L$ =50 $\Omega$		200		ns
Turn-Off Time	T <sub>OFF</sub>	$V_{COM}$ =1.5V, $C_L$ =35pF, $R_L$ =50 $\Omega$		200		ns
Break-Before-Make time	T <sub>BBM</sub>	$V_{COM}$ =1.5V, $C_L$ =35pF, $R_L$ =50 $\Omega$		500		ns
-3dB Bandwidth	BW	R <sub>L</sub> =50Ω, C <sub>L</sub> =0pF		850		MHz
Off isolation	OIRR	F=1KHz, R <sub>L</sub> =50Ω		-81		dB
On isolation		F=10KHz, R <sub>L</sub> =50Ω		-80		dB
Crantally	Xtalk	F=1KHz, R <sub>L</sub> =50Ω		-83		dB
Crosstalk		F=10KHz, R <sub>L</sub> =50Ω		-82		dB
Total Harmonic Distortion	TUD	F=20Hz to 20KHz		00		٩D
Total Harmonic Distortion	THD	V <sub>COM</sub> =600mVp-p @R <sub>L</sub> =32Ω,		-80		dB

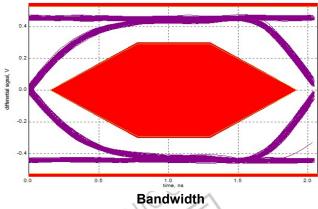


Capacitance (Ta=25°C, VCC=3.3V, unless otherwise noted)

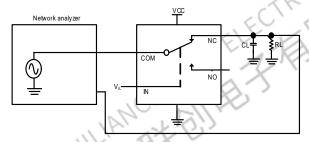
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Off capacitance	C <sub>OFF</sub>	F=100KHz		5		pF
On capacitance	Con	F=100KHz		7		pF

# Typical Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

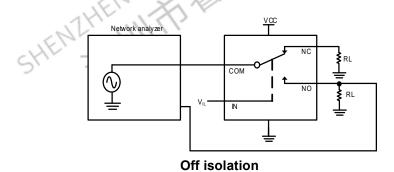


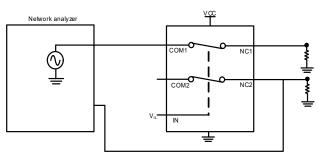


Eye Diagram (480Mbps)



## Bandwidth



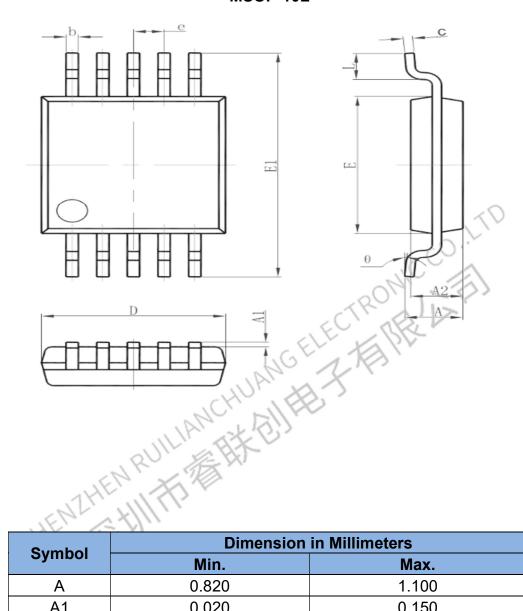


Crosstalk



#### **Package Outline Dimensions**

#### MSOP-10L



Symbol	Dimension in Millimeters			
Symbol	Min.	Max.		
Α	0.820	1.100		
A1	0.020	0.150		
A2	0.750	0.950		
b	0.180	0.280		
С	0.090	0.230		
D	2.900	3.100		
е	0.50	0.50(BSC)		
E	2.900	3.100		
E1	4.750	5.050		
L	0.400	0.800		
θ	0°	0° 6°		



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